# **UM11911**

## Introduction to FRDM-STBA-A8961 sensor toolbox development board

Rev. 1 — 31 March 2023 User manual

#### **Document information**

Information	Content
Keywords	FXLS8961AF, 3-axis accelerometer, sensor toolbox development board, precision leveling, angle measurement
Abstract	This document describes details about FRDM-STBA-A8961 sensor toolbox development board for FXLS8961AF 3-axis accelerometer. This document also provides instructions to get started with FRDM-STBA-A8961 board.



#### Introduction to FRDM-STBA-A8961 sensor toolbox development board

#### **Revision history**

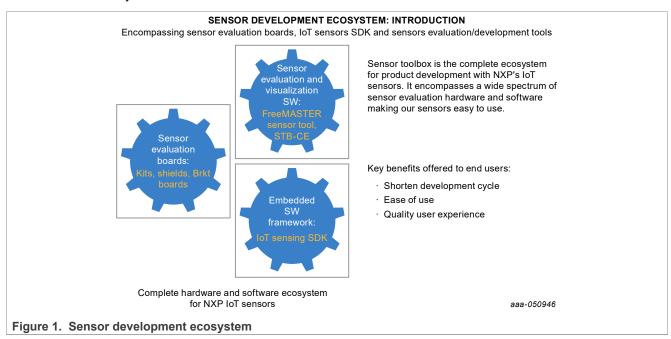
Rev	Date	Description
v.1	20230331	initial release

Introduction to FRDM-STBA-A8961 sensor toolbox development board

#### 1 Introduction

This document describes the details about the FRDM-STBA-A8961 sensor toolbox development board for the FXLS8961AF<sup>[2]</sup> 3-axis accelerometer. This user manual also provides instructions to get started with the FRDM-STBA-A8961 board to accelerate evaluation and development with the FXLS8961AF.

The Sensor Toolbox Ecosystem<sup>[3]</sup> offers unmatched enablement and development flexibility with software and tools to simplify a customer's evaluation, development, and design using NXP's sensors. FRDM-STBA-A8961 sensor development board for FXLS8961AF is offered along with supported software collaterals through the sensor toolbox ecosystem.



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## 2 Finding kit resources and information on the NXP web site

NXP Semiconductors provides online resources for this evaluation board and its supported device(s) on sensors evaluation boards page<sup>[4]</sup>.

The information page for FRDM-STBA-A8961 sensor toolbox development board is available at <a href="https://www.nxp.com/FRDM-STBA-A8961">https://www.nxp.com/FRDM-STBA-A8961</a>. The information page provides overview information, documentation, software and tools, ordering information and a Getting Started tab. The Getting Started tab provides quick-reference information applicable to using the FRDM-STBA-A8961 development board, including the downloadable assets referenced in this document.

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## 3 Getting ready

#### 3.1 Kit contents

The FRDM-STBA-A8961 sensor toolbox development board includes:

- FRDM-STBA-A8961: FXLS8961AF sensor shield board
- · Quick Start Guide

#### 3.2 Developer resources

The following developer resources are recommended to jump-start the evaluation or development using the FRDM-STBA-A8961 board:

- Get Started with FRDM-STBA-A8961 evaluation board
- Get Started with IoT Sensing SDK
- Get Started with FreeMASTER-Sensor-Tool

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### 4 Getting to know the hardware

#### 4.1 Kit overview

The FRDM-STBA-A8961 sensor evaluation board is offered as a sensor shield/expansion board only and can be kitted with the LPC55S16-EVK or the FRDM-K22F MCU board.

**Note:** The user needs to order the MCU board separately.

The sensor shield board includes the following sensor part:

• FXLS8961AF<sup>[2]</sup>: 3-axis digital accelerometer

The FRDM-STBA-A8961 sensor board enables quick customer evaluation of the FXLS8961AF using the sensor toolbox enablement software and tools.

#### 4.2 Board features

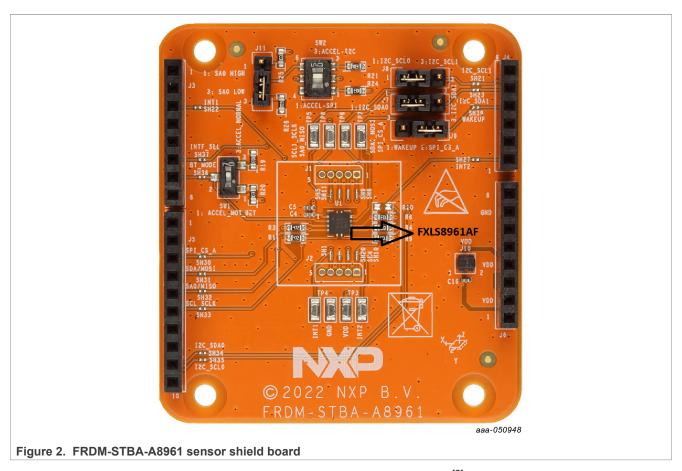
- Sensor shield/expansion board for the FXLS8961AF 3-axis accelerometer for automotive security and convenience applications requiring excellent offset/sensitivity stability over temperature.
- Compatible with Arduino® and most NXP Freedom development boards. This sensor shield board can be kitted with LPC55S16-EVK or FRDM-K22F MCU boards.
- Enables quick sensor evaluation and helps accelerate quick prototyping and development.
- · Allows evaluation of current consumption and pin-voltage characteristics.
- Supports I<sup>2</sup>C and SPI communication interface with the host MCU.
- Supports hardware configurability to Switch Accelerometer mode (normal vs motion detect) and I<sup>2</sup>C/SPI Interface mode.
- · Supports multiple test points on the board.

#### 4.3 Kit featured components

The combination of a shield development board and a freedom development MCU board enable a complete solution for quick sensor evaluation, prototyping, and development using the sensor toolbox development ecosystem.

The board is designed to be fully compatible with Arduino I/O headers and optimized for the operating conditions. The FRDM-STBA-A8961 sensor shield board can be powered up by the LPC55S16-EVK or the FRDM-K22F MCU board by stacking the shield board on top of the MCU board using Arduino I/O headers, as shown in <a href="Figure 2">Figure 2</a>, and connecting the MCU board to the PC via the USB cable between the LINK2 or OpenSDA USB port on the MCU board and the USB connector on the PC.

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This sensor kit is enabled with the FreeMASTER-Sensor-Tool software tool<sup>[6]</sup> providing an out-of-box demonstration GUI. The sensor toolbox ecosystem collaterals enable end users to move through each phase of product development quickly and increase ease of use.

#### 4.4 Schematic, board layout and bill of materials

The schematic, board layout and bill of materials for the FRDM-STBI-A8971 evaluation board are available at <a href="https://www.nxp.com/FXLS8961AF">www.nxp.com/FXLS8961AF</a>.

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#### 5 Configuring the hardware

- 1. Check and confirm the FRDM-STBA-A8961 sensor shield board settings as described below:
  - To select the I<sup>2</sup>C digital interface, connect pins 2-3 of SW2 on the FRDM-STBA-A8961.
  - To select SPI digital interface, connect pins 1-2 of SW2 on the FRDM-STBA-A8961.
  - Connect pins 2-3 of SW1 to select the default Accelerometer Operating mode, that is, ACCEL NORMAL mode.
- 2. Using with the LPC55S16-EVK:
  - Connect the FRDM-STBA-A8961 sensor shield board to the LPC55S16-EVK MCU board on the Arduino I/O headers.
  - Connect J7, J8 pins 1-2 to select I<sup>2</sup>C0 pins on shield board.
  - Connect the sensor evaluation sit (FRDM-STBA-A8961 kitted with the LPC55S16-EVK) to the windows PC via the USB cable between the LINK2 USB port on the board and the USB connector on the PC.
- 3. Using with the FRDM-K22F:
  - Connect the FRDM-STBA-A8961 sensor shield board to the FRDM-K22F MCU board on Arduino I/O headers.
  - Connect J7, J8 pins 2-3 to select I<sup>2</sup>C1 pins on the shield board.
  - Connect the sensor evaluation kit (FRDM-STBA-A8961 kitted with the FRDM-K22F) to the windows PC via the USB cable between the OpenSDA USB port on the board and the USB connector on the PC.

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#### 6 References

- [1] Motion Sensors Accelerometers for IoT, Industrial and Medical applications, Motion-Sensors or Accelerometers
- [2] FXLS8961AF 3-axis Accelerometer ideal for precision leveling and angle measurement, FXLS8961AF
- [3] **Sensors Development Ecosystem** Complete ecosystem for product development with NXP's sensors targeted toward IoT, Industrial, Medical applications, Sensor-Toolbox
- [4] Sensor Evaluation Boards Sensor Toolbox Development Kits, Sensor Evaluation Boards
- [5] ISSDK IoT Sensing SDK: framework enabling embedded development using sensors, ISSDK
- [6] FreeMASTER-Sensor-Tool Sensor evaluation and application development software, FreeMASTER-Sensor-Tool

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## **Figures**

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